**附件1： 2023多孔介质研讨会暨SPWLA亚太区专题会议-参会回执**

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| 单 位 |  | | | | | |
| 地 址 |  | | | | 邮编 |  |
| 姓 名 | 部门 | 职 务 | 职称 | 电 话 | 电 子 信 箱 | |
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